

GENERAL DESCRIPTION

The SGM4519 is configured as two 4-channel, TTL/CMOS compatible analog multiplexers. It operates from +3.2V to +36V single power supply or $\pm 3.2V$ to $\pm 18V$ dual power supplies.

The SGM4519 features high voltage, low on-resistance and low distortion. The high performances make it very suitable for multiple applications, such as battery-operated equipment, audio and video signal routing, etc.

TTL/CMOS logic compatibility can be guaranteed when using a single +5V or dual $\pm 5V$ power supplies because the logic thresholds of all digital inputs are between 0.8V and 2.4V.

The SGM4519 is available in Green SOIC-16, SSOP-16, TSSOP-16 and TQFN-3 \times 3-16L packages. It operates over an operating temperature range of $-40^{\circ}C$ to $+125^{\circ}C$.

FEATURES

- **Single Supply Voltage Range: +3.2V to +36V**
- **Dual-Supply Voltage Range: $\pm 3.2V$ to $\pm 18V$**
- **High Off-Isolation: -88dB ($R_L = 50\Omega$, $f = 1MHz$)**
- **On-Resistance:**
 - 22 Ω (TYP) with Single 36V Supply**
- **Low On-Resistance Flatness**
- **Low Off-Leakage Current: 0.01 μA (TYP) at $+25^{\circ}C$**
- **Low On-Leakage Current: 0.01 μA (TYP) at $+25^{\circ}C$**
- **Low Crosstalk: -97dB (TYP) ($R_L = 50\Omega$, $f = 1MHz$)**
- **Low Distortion: 0.001% ($R_L = 600\Omega$, $f = 1kHz$)**
- **Rail-to-Rail Input and Output Operation**
- **TTL/CMOS-Logic Compatible**
- **$-40^{\circ}C$ to $+125^{\circ}C$ Operating Temperature Range**
- **Available in Green SOIC-16, SSOP-16, TSSOP-16 and TQFN-3 \times 3-16L Packages**

APPLICATIONS

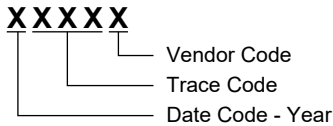
Portable Equipment
Sample-and-Hold Circuits
Battery-Powered Systems
Audio and Video Signal Routing

PACKAGE/ORDERING INFORMATION

| MODEL | PACKAGE DESCRIPTION | SPECIFIED TEMPERATURE RANGE | ORDERING NUMBER | PACKAGE MARKING | PACKING OPTION |
|---------|---------------------|-----------------------------|------------------|---------------------------|---------------------|
| SGM4519 | SOIC-16 | -40°C to +125°C | SGM4519XS16G/TR | SGM4519XS16 XXXXX | Tape and Reel, 2500 |
| | SSOP-16 | -40°C to +125°C | SGM4519XQS16G/TR | SGM4519 XQS16 XXXXX | Tape and Reel, 4000 |
| | TSSOP-16 | -40°C to +125°C | SGM4519XTS16G/TR | SGM4519 XTS16 XXXXX | Tape and Reel, 4000 |
| | TQFN-3x3-16L | -40°C to +125°C | SGM4519XTQ16G/TR | 4519TQ XXXXX | Tape and Reel, 4000 |

MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS

- Voltages Referenced to V_{EE}
- V_{CC} -0.3V to 40V
- GND -0.3V to 40V
- Analog Switch I/O Voltage, V_{IS}.....(V_{EE} - 0.3V) to (V_{CC} + 0.3V)
- Digital Control Voltage(GND - 0.3V) to (V_{CC} + 0.3V)
- Continuous Current into Analog Switch I/O, X₋, Y₋⁽¹⁾ or X, Y ±40mA
- Junction Temperature +150°C
- Storage Temperature Range -65°C to +150°C
- Lead Temperature (Soldering, 10s) +260°C
- ESD Susceptibility
- HBM 3000V
- CDM 1000V

RECOMMENDED OPERATING CONDITIONS

- Operating Temperature Range -40°C to +125°C

NOTE:

1. X₋: Analog Switch Inputs X0-X3.
 Y₋: Analog Switch Inputs Y0-Y3.

OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

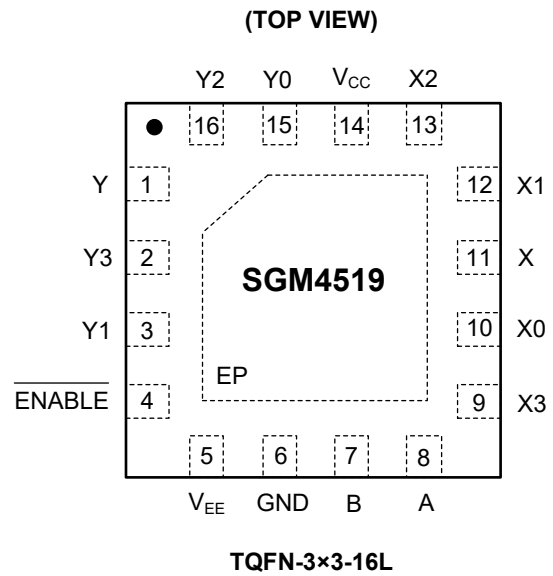
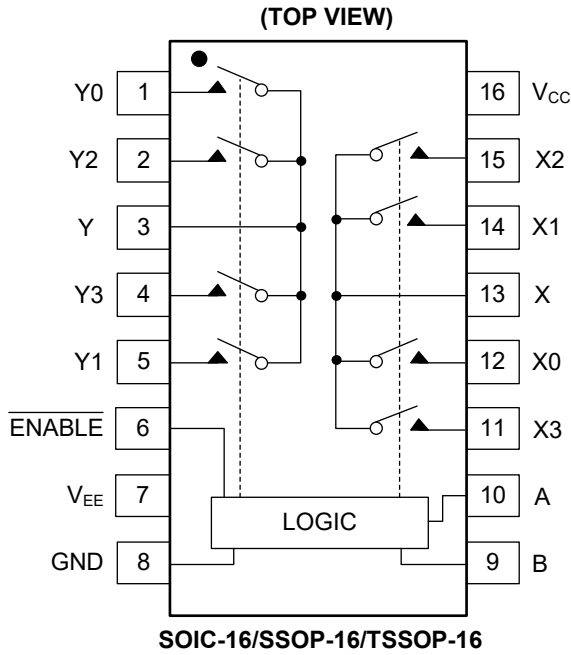
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS



PIN DESCRIPTION

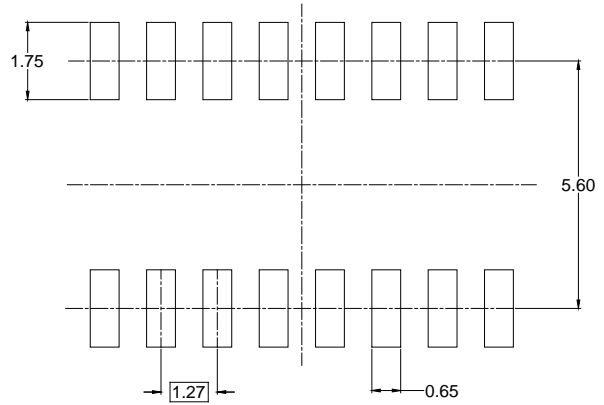
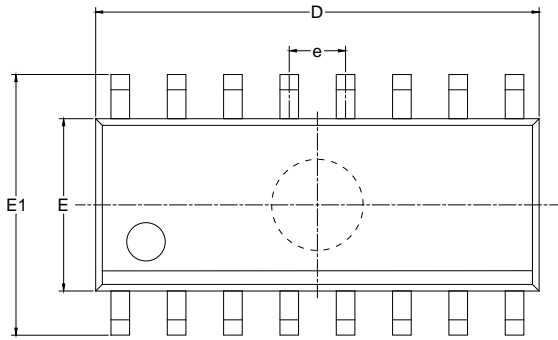
| PIN | | NAME | FUNCTION |
|----------------------------|---------------|-----------------|---|
| SOIC-16, SSOP-16, TSSOP-16 | TQFN-3x3-16L | | |
| 13 | 11 | X | Analog Switch "X" Output Pin. |
| 12, 14, 15, 11 | 10, 12, 13, 9 | X0, X1, X2, X3 | Analog Switch "X" Inputs 0-3. |
| 1, 5, 2, 4 | 15, 3, 16, 2 | Y0, Y1, Y2, Y3 | Analog Switch "Y" Inputs 0-3. |
| 3 | 1 | Y | Analog Switch "Y" Output Pin. |
| 16 | 14 | V _{CC} | Positive Analog and Digital Supply Voltage Input Pin. |
| 10 | 8 | A | Digital Address "A" Input Pin. |
| 9 | 7 | B | Digital Address "B" Input Pin. |
| 8 | 6 | GND | Ground. |
| 7 | 5 | V _{EE} | Negative Analog Supply Voltage Input Pin. Connect to GND for single-supply operation. |
| 6 | 4 | ENABLE | Digital Enable Control Input Pin (Active Low). Normally connected to GND. |
| — | Exposed Pad | EP | Exposed Pad. It can be connected to V _{EE} or be left floating. |

NOTE:

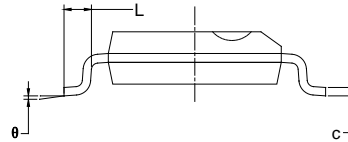
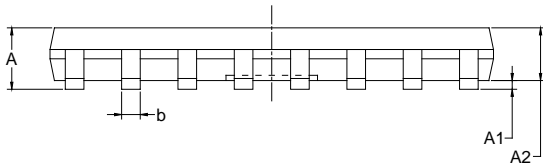
Any input terminal can be used as an output terminal, and any output terminal can also be used as an input terminal. Signal transmission in both directions is equally well.

PACKAGE OUTLINE DIMENSIONS

SOIC-16



RECOMMENDED LAND PATTERN (Unit: mm)



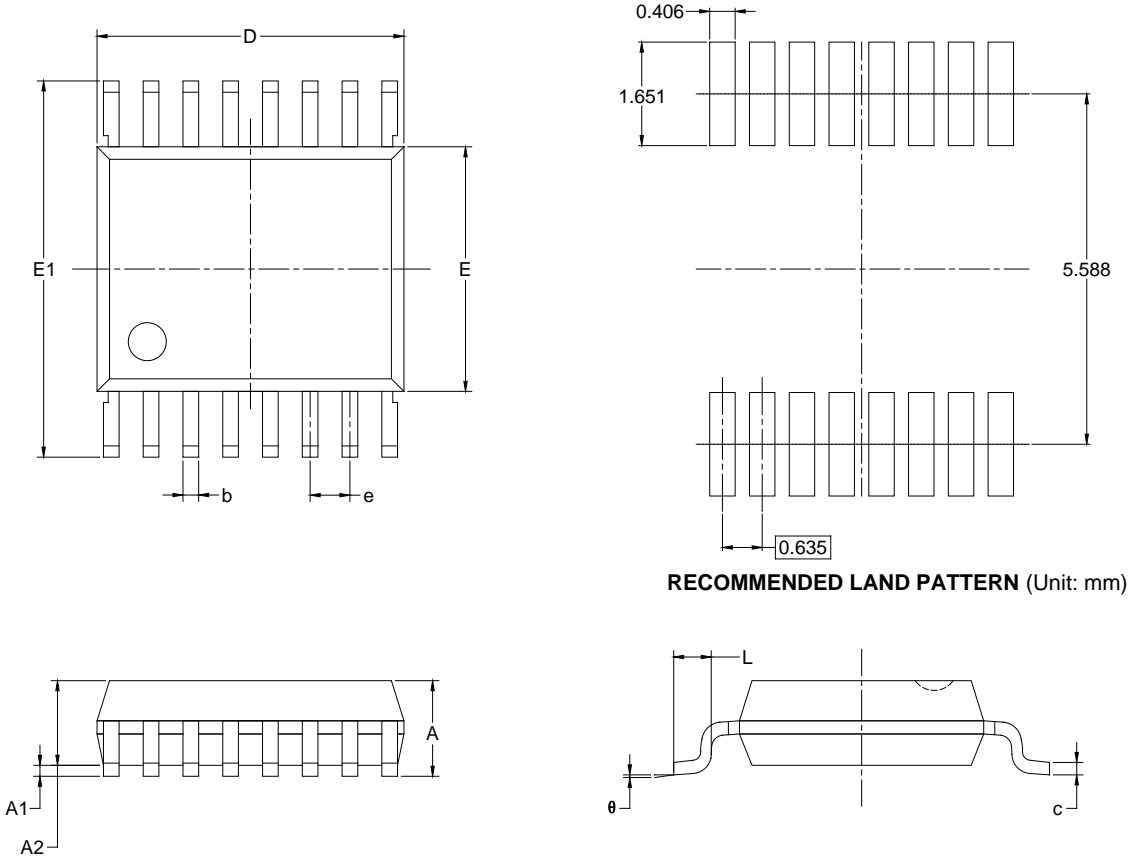
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|------------------------------|--------|-------------------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.330 | 0.510 | 0.013 | 0.020 |
| c | 0.170 | 0.250 | 0.006 | 0.010 |
| D | 9.800 | 10.200 | 0.386 | 0.402 |
| E | 3.800 | 4.000 | 0.150 | 0.157 |
| E1 | 5.800 | 6.200 | 0.228 | 0.244 |
| e | 1.27 BSC | | 0.050 BSC | |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| θ | 0° | 8° | 0° | 8° |

NOTES:

1. Body dimensions do not include mode flash or protrusion.
2. This drawing is subject to change without notice.

PACKAGE OUTLINE DIMENSIONS

SSOP-16



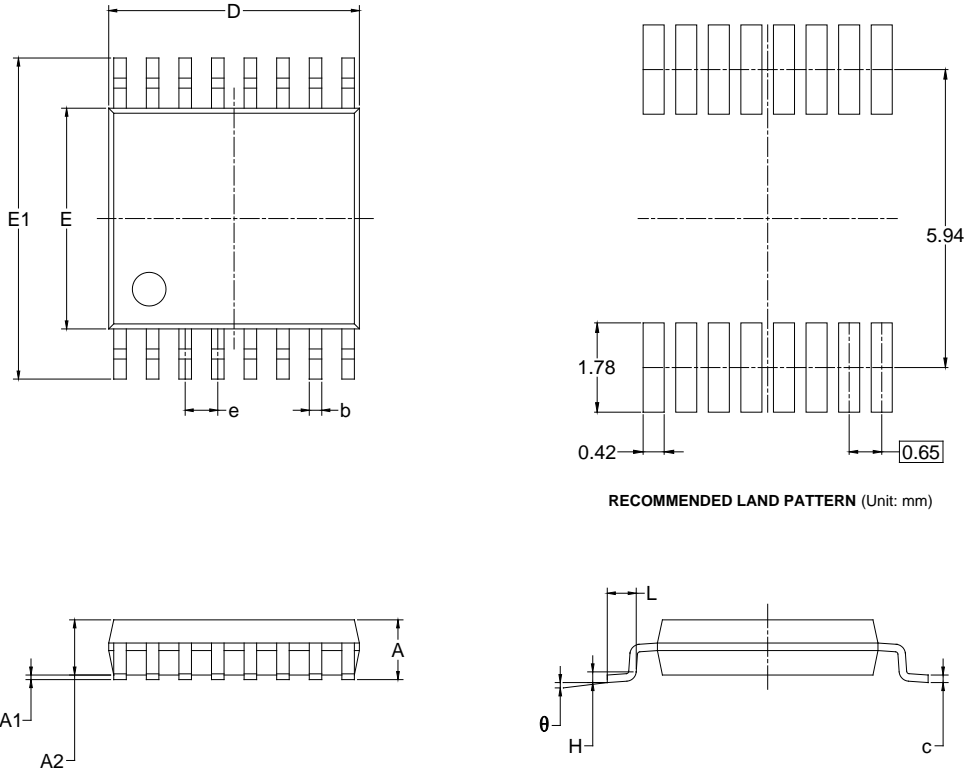
RECOMMENDED LAND PATTERN (Unit: mm)

| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|------------------------------|-------|-------------------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 1.350 | 1.750 | 0.053 | 0.069 |
| A1 | 0.100 | 0.250 | 0.004 | 0.010 |
| A2 | 1.350 | 1.550 | 0.053 | 0.061 |
| b | 0.200 | 0.300 | 0.008 | 0.012 |
| c | 0.170 | 0.250 | 0.007 | 0.010 |
| D | 4.700 | 5.100 | 0.185 | 0.200 |
| E | 3.800 | 4.000 | 0.150 | 0.157 |
| E1 | 5.800 | 6.200 | 0.228 | 0.244 |
| e | 0.635 BSC | | 0.025 BSC | |
| L | 0.400 | 1.270 | 0.016 | 0.050 |
| θ | 0° | 8° | 0° | 8° |

NOTES:
 1. Body dimensions do not include mode flash or protrusion.
 2. This drawing is subject to change without notice.

PACKAGE OUTLINE DIMENSIONS

TSSOP-16



RECOMMENDED LAND PATTERN (Unit: mm)

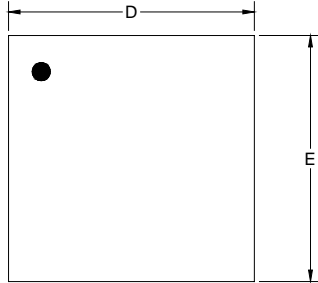
| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|----------|------------------------------|-------|-------------------------|-------|
| | MIN | MAX | MIN | MAX |
| A | | 1.200 | | 0.047 |
| A1 | 0.050 | 0.150 | 0.002 | 0.006 |
| A2 | 0.800 | 1.050 | 0.031 | 0.041 |
| b | 0.190 | 0.300 | 0.007 | 0.012 |
| c | 0.090 | 0.200 | 0.004 | 0.008 |
| D | 4.860 | 5.100 | 0.191 | 0.201 |
| E | 4.300 | 4.500 | 0.169 | 0.177 |
| E1 | 6.200 | 6.600 | 0.244 | 0.260 |
| e | 0.650 BSC | | 0.026 BSC | |
| L | 0.500 | 0.700 | 0.02 | 0.028 |
| H | 0.25 TYP | | 0.01 TYP | |
| θ | 1° | 7° | 1° | 7° |

- NOTES:
1. Body dimensions do not include mode flash or protrusion.
 2. This drawing is subject to change without notice.

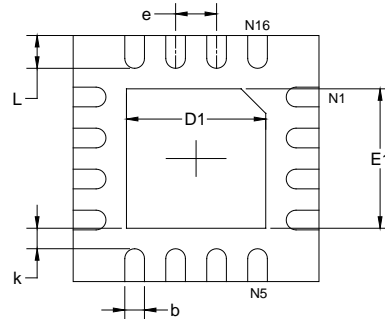
PACKAGE INFORMATION

PACKAGE OUTLINE DIMENSIONS

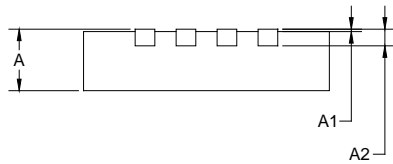
TQFN-3x3-16L



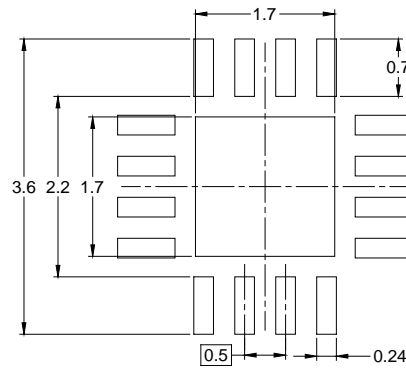
TOP VIEW



BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN (Unit: mm)

| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|------------------------------|-------|-------------------------|-------|
| | MIN | MAX | MIN | MAX |
| A | 0.700 | 0.800 | 0.028 | 0.031 |
| A1 | 0.000 | 0.050 | 0.000 | 0.002 |
| A2 | 0.203 REF | | 0.008 REF | |
| D | 2.900 | 3.100 | 0.114 | 0.122 |
| D1 | 1.600 | 1.800 | 0.063 | 0.071 |
| E | 2.900 | 3.100 | 0.114 | 0.122 |
| E1 | 1.600 | 1.800 | 0.063 | 0.071 |
| k | 0.200 MIN | | 0.008 MIN | |
| b | 0.180 | 0.300 | 0.007 | 0.012 |
| e | 0.500 TYP | | 0.020 TYP | |
| L | 0.300 | 0.500 | 0.012 | 0.020 |

NOTE: This drawing is subject to change without notice.

PACKAGE INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF TAPE AND REEL

| Package Type | Reel Diameter | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P0 (mm) | P1 (mm) | P2 (mm) | W (mm) | Pin1 Quadrant |
|--------------|---------------|--------------------|---------|---------|---------|---------|---------|---------|--------|---------------|
| SOIC-16 | 13" | 16.4 | 6.50 | 10.30 | 2.10 | 4.0 | 8.0 | 2.0 | 16.0 | Q1 |
| SSOP-16 | 13" | 12.4 | 6.40 | 5.40 | 2.10 | 4.0 | 8.0 | 2.0 | 12.0 | Q1 |
| TSSOP-16 | 13" | 12.4 | 6.90 | 5.60 | 1.20 | 4.0 | 8.0 | 2.0 | 12.0 | Q1 |
| TQFN-3×3-16L | 13" | 12.4 | 3.35 | 3.35 | 1.13 | 4.0 | 8.0 | 2.0 | 12.0 | Q2 |

D00001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

| Reel Type | Length (mm) | Width (mm) | Height (mm) | Pizza/Carton |
|-----------|-------------|------------|-------------|--------------|
| 13" | 386 | 280 | 370 | 5 |

DD0002